## MMBT6520L, NSVMMBT6520L

## **High Voltage Transistor**

## **PNP Silicon**

#### **Features**

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	-350	Vdc
Collector - Base Voltage	V <sub>CBO</sub>	-350	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	Vdc
Base Current	Ι <sub>Β</sub>	-250	mA
Collector Current – Continuous	I <sub>C</sub>	-500	mAdc

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, (Note 1) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

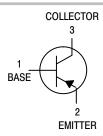
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1.  $FR-5 = 1.0 \times 0.75 \times 0.062$  in.
- 2. Alumina =  $0.4 \times 0.3 \times 0.024$  in. 99.5% alumina.



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SOT-23 (TO-236) CASE 318 STYLE 6

## MARKING DIAGRAM



2Z = Device Code

M = Date Code\*

■ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMBT6520LT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
MMBT6520LT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel
NSVMMBT6520LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## MMBT6520L, NSVMMBT6520L

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25$ °C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = -1.0 mA)	V <sub>(BR)CEO</sub>	-350	-	Vdc
Collector–Base Breakdown Voltage (I <sub>C</sub> = –100 μA)	V <sub>(BR)</sub> CBO	-350	-	Vdc
Emitter–Base Breakdown Voltage (I <sub>E</sub> = –10 μA)	V <sub>(BR)EBO</sub>	-5.0	-	Vdc
Collector Cutoff Current (V <sub>CB</sub> = -250 V)	I <sub>CBO</sub>	_	-50	nA
Emitter Cutoff Current (V <sub>EB</sub> = -4.0 V)	I <sub>EBO</sub>	_	-50	nA
ON CHARACTERISTICS	•			
DC Current Gain	h <sub>FE</sub>	20 30 30 20 15	- 200 200 -	-
Collector–Emitter Saturation Voltage $ \begin{array}{l} (I_C=-10 \text{ mA},\ I_B=-1.0 \text{ mA}) \\ (I_C=-20 \text{ mA},\ I_B=-2.0 \text{ mA}) \\ (I_C=-30 \text{ mA},\ I_B=-3.0 \text{ mA}) \\ (I_C=-50 \text{ mA},\ I_B=-5.0 \text{ mA}) \end{array} $	V <sub>CE(sat)</sub>	- - - -	-0.30 -0.35 -0.50 -1.0	Vdc
Base–Emitter Saturation Voltage $ \begin{array}{l} (I_C = -10 \text{ mA}, I_B = -1.0 \text{ mA}) \\ (I_C = -20 \text{ mA}, I_B = -2.0 \text{ mA}) \\ (I_C = -30 \text{ mA}, I_B = -3.0 \text{ mA}) \end{array} $	V <sub>BE(sat)</sub>	- - -	-0.75 -0.85 -0.90	Vdc
Base–Emitter On Voltage (I <sub>C</sub> = -100 mA, V <sub>CE</sub> = -10 V)	V <sub>BE(on)</sub>	_	-2.0	Vdc
SMALL-SIGNAL CHARACTERISTICS	1	•		<u>'</u>
Current–Gain – Bandwidth Product $(I_C = -10 \text{ mA}, V_{CE} = -20 \text{ V}, f = 20 \text{ MHz})$	f <sub>T</sub>	40	200	MHz
Collector–Base Capacitance (V <sub>CB</sub> = -20 V, f = 1.0 MHz)	C <sub>cb</sub>	_	6.0	pF
Emitter–Base Capacitance $(V_{EB}=-0.5 \text{ V}, f=1.0 \text{ MHz})$	C <sub>eb</sub>	_	100	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## MMBT6520L, NSVMMBT6520L

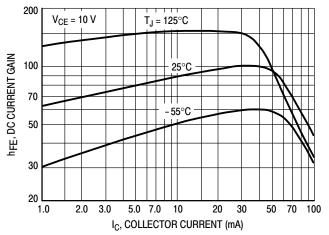


Figure 1. DC Current Gain

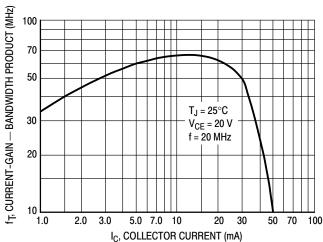


Figure 2. Current-Gain — Bandwidth Product

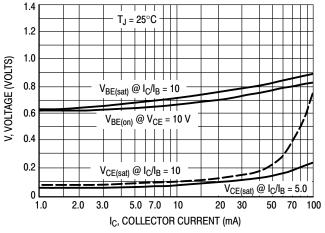
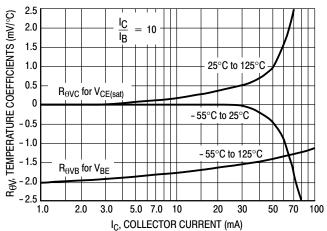


Figure 3. "On" Voltages



**Figure 4. Temperature Coefficients** 

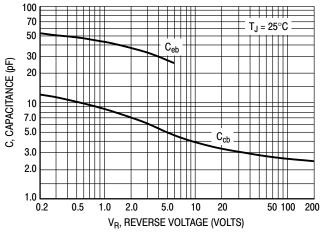


Figure 5. Capacitance

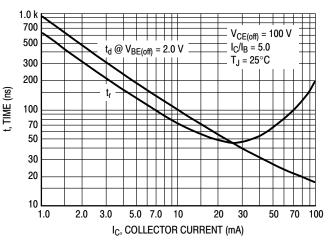


Figure 6. Turn-On Time

## MMBT6520L, NSVMMBT6520L

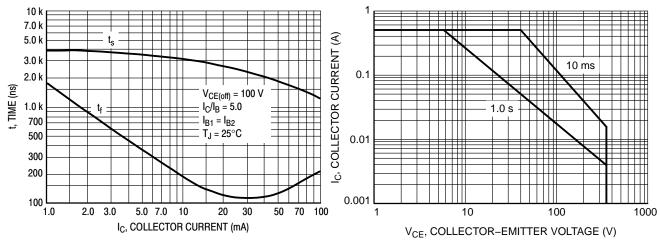


Figure 7. Turn-Off Time

Figure 8. Safe Operating Area

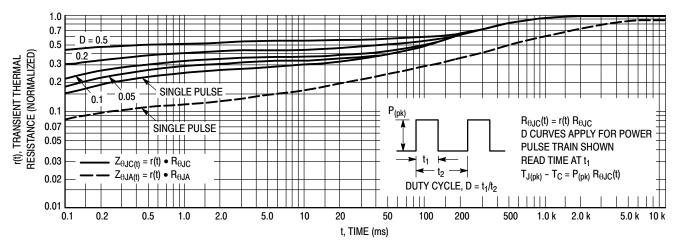


Figure 9. Thermal Response

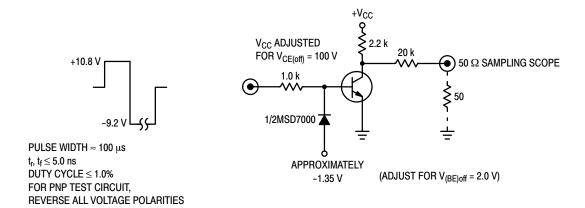


Figure 10. Switching Time Test Circuit

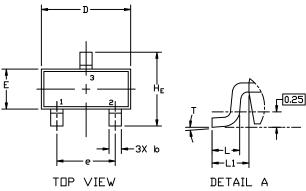




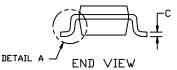
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**DATE 01 MAR 2023** 









#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M,1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIM	ETERS		INCHES		
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.
Α	0.89	1.00	1.11	0.035	0.039	0.044
A1	0.01	0.06	0.10	0.000	0.002	0.004
b	0.37	0.44	0.50	0.015	0.017	0.020
С	0.08	0.14	0.20	0.003	0.006	0.008
D	2.80	2.90	3.04	0.110	0.114	0.120
Ε	1.20	1.30	1.40	0.047	0.051	0.055
e	1.78	1.90	2.04	0.070	0.075	0.080
L	0.30	0.43	0.55	0.012	0.017	0.022
L1	0.35	0.54	0.69	0.014	0.021	0.027
HE	2.10	2.40	2.64	0.083	0.094	0.104
Т	0*		10°	0*		10°

# GENERIC MARKING DIAGRAM\*

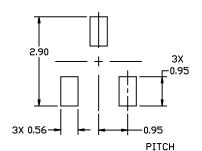


XXX = Specific Device Code

M = Date Code

■ = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

## **STYLES ON PAGE 2**

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# MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



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**DATE 01 MAR 2023** 

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR	STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE	1	
STYLE 9: PIN 1. ANODE 2. ANODE 3. CATHODE	STYLE 10: PIN 1. DRAIN 2. SOURCE 3. GATE	STYLE 11: PIN 1. ANODE 2. CATHODE 3. CATHODE-ANODE	STYLE 12: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 13: PIN 1. SOURCE 2. DRAIN 3. GATE	STYLE 14: PIN 1. CATHODE 2. GATE 3. ANODE
STYLE 15: PIN 1. GATE 2. CATHODE 3. ANODE	STYLE 16: PIN 1. ANODE 2. CATHODE 3. CATHODE	STYLE 17: PIN 1. NO CONNECTION 2. ANODE 3. CATHODE	STYLE 18: PIN 1. NO CONNECTION 2. CATHODE 3. ANODE	STYLE 19: I PIN 1. CATHODE 2. ANODE 3. CATHODE-ANODE	STYLE 20: PIN 1. CATHODE 2. ANODE 3. GATE
STYLE 21: PIN 1. GATE 2. SOURCE 3. DRAIN	STYLE 22: PIN 1. RETURN 2. OUTPUT 3. INPUT	STYLE 23: PIN 1. ANODE 2. ANODE 3. CATHODE	STYLE 24: PIN 1. GATE 2. DRAIN 3. SOURCE	STYLE 25: PIN 1. ANODE 2. CATHODE 3. GATE	STYLE 26: PIN 1. CATHODE 2. ANODE 3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE				

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